

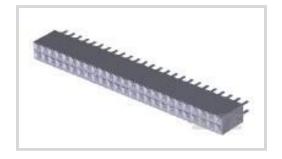
## AMPMODU | Modu Connector System

TE Internal #: 2-534206-5 PCB Mount Receptacle, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System

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Connectors > PCB Connectors > PCB Headers & Receptacles



## PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **50** 

Number of Rows: 2

## Features

## **Product Type Features**

Applied Pressure

PCB Connector Assembly Type

Connector System

Standard

PCB Mount Receptacle

Board-to-Board

Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Stackable	Yes			
PCB Mount Orientation	Vertical			
Number of Positions	50			
Number of Rows	2			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Insulation Resistance	5000 MΩ			
Operating Voltage	333 VAC			
Body Features				
Connector Profile	Standard			
Primary Product Color	Black			
Contact Features				

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Contact Protection Type	Closed Entry Housing	
Mating Square Post Dimension	.64 mm[.025 in]	
	150 µin	
Contact Shape & Form	Square	
PCB Contact Termination Area Plating Material	Tin-Lead	
Contact Base Material	Phosphor Bronze	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]	
Contact Type	Socket	
Contact Current Rating (Max)	2 A	
Termination Features		
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]	
Rectangular Termination Post & Tail Width	.69 mm[.027 in]	
Termination Post & Tail Length	2.92 mm[.115 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Mating Entry Location	Тор	
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Polyester - GF	
Dimensions		
Connector Height	5.03 mm[.198 in]	
Row-to-Row Spacing	2.54 mm[.1 in]	
Stack Height	10.92 mm[.43 in]	
PCB Thickness (Recommended)	1.57 mm[.055 – .094 in]	
Jsage Conditions		
Housing Temperature Rating	Standard	

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## **Operation/Application**

Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	9	
Packaging Type	Box, Tube	
Product Compliance		
For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Not Compliant	
EU ELV Directive 2000/53/EC	Compliant with Exemptions	
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235)	

### Halogen Content

Solder Process Capability

### 2023 (235)

SVHC > Threshold:

## Pb (13% in Component Part)

#### Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Not Low Halogen - contains Br or Cl > 900

ppm.

Wave solder capable to 240°C

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

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# Also in the Series | Modu Connector System

Automotive Housings(2)	Board-to-Board Jumpers & Shunts(5)	Connector Caps & Covers(4)	PCB Connector Keying(4)



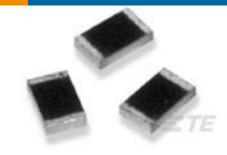
# Customers Also Bought

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TE Part #4-1879280-6 RP 2A 200K 0.1% 15PPM CUT LENGTH

## Documents

Product Drawings 50 MODII VRT DR CE 100/115

English

CAD Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_2-534206-5\_N.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_2-534206-5\_N.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_2-534206-5\_N.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

**Product Specifications** 

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Application Specification

English

Product Environmental ComplianceProduct ComplianceEnglishProduct Compliance

English